

# Technical Data Sheet

## 1206 Package Infrared Chip LED

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**HIR15-21C/TR8**

### Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector



### Descriptions

HIR15-21C/TR8 is an infrared emitting diode in miniature SMD package molded in a water clear plastic with flat top view lens. The spectrally device is matched silicon with photodiode and phototransistor.

### Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

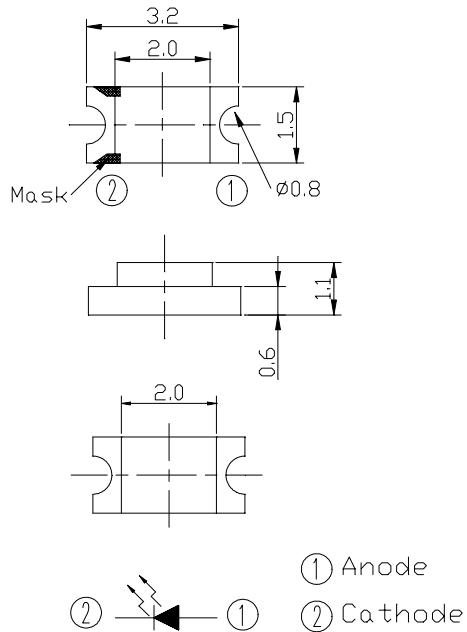
### Device Selection Guide

LED Part No.	Chip	Lens Color
	Material	
HIR	GaAlAs	Water Clear

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**Device No:DTH-.015-001**

### Package Dimensions



**Notes:** 1. All dimensions are in millimeters

2. Tolerances unless dimensions  $\pm 0.1\text{mm}$

### Absolute Maximum Ratings ( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_F$	65	mA
Peak Forward Current	$I_{FP}$	1.0	A
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	$-25 \sim +85$	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	$-40 \sim +85$	$^\circ\text{C}$
Soldering Temperature	$T_{sol}$	260	$^\circ\text{C}$
Power Dissipation at(or below) $25^\circ\text{C}$ Free Air Temperature	$P_d$	130	mW

**Notes:** \*1:  $I_{FP}$  Conditions--Pulse Width  $\leq 100\ \mu\text{s}$  and Duty  $\leq 1\%$ .

\*2:Soldering time  $\leq 5$  seconds.

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**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Radiant Intensity	E <sub>e</sub>	I <sub>F</sub> =20mA	0.5	1.5	--	mW/sr
Peak Wavelength	λ <sub>p</sub>	I <sub>F</sub> =20mA	--	850	--	nm
Spectral Bandwidth	Δ λ	I <sub>F</sub> =20mA	--	45	--	nm
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	--	1.45	1.65	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	--	--	10	μA
View Angle	2θ 1/2	I <sub>F</sub> =20mA	--	150	--	deg

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**Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs. Ambient Temperature

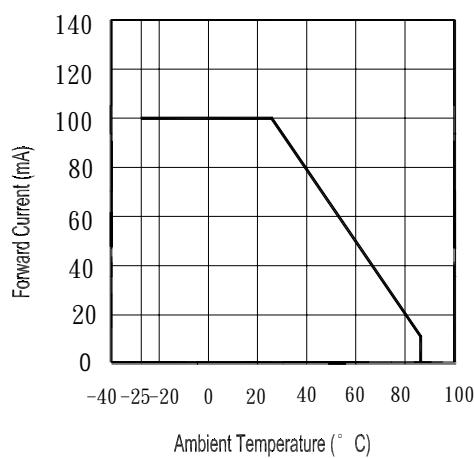


Fig.3 Peak Emission Wavelength vs. Ambient Temperature

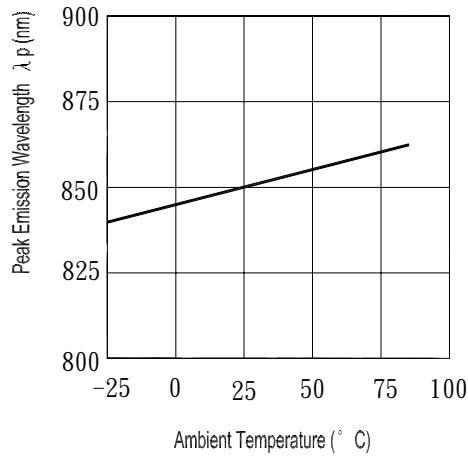


Fig.2 Spectral Distribution

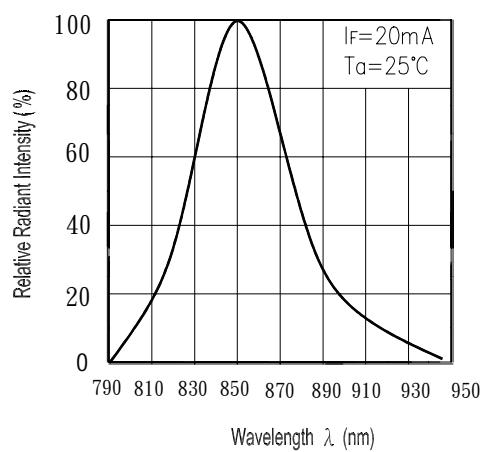
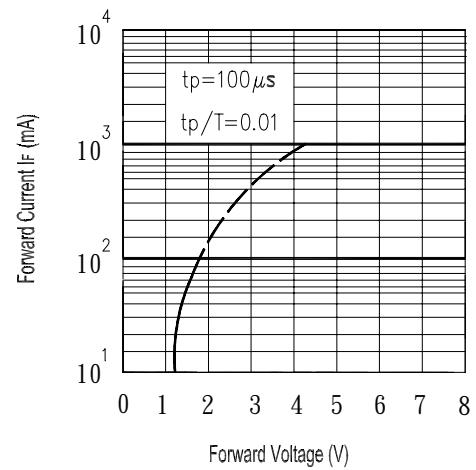


Fig.4 Forward Current vs. Forward Voltage



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**Typical Electro-Optical Characteristics Curves**

Fig. 5 Relative Intensity vs. Forward Current

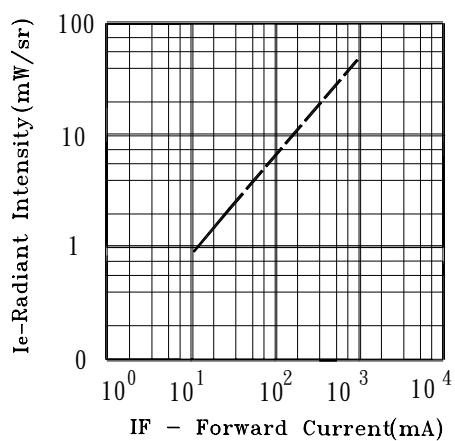


Fig. 6 Relative Radiant Intensity vs. Angular Displacement

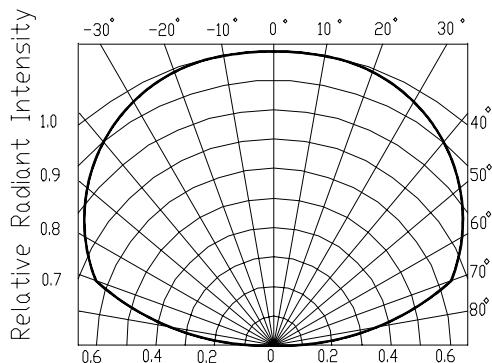


Fig. 7 Relative Intensity vs. Ambient Temperature (°C)

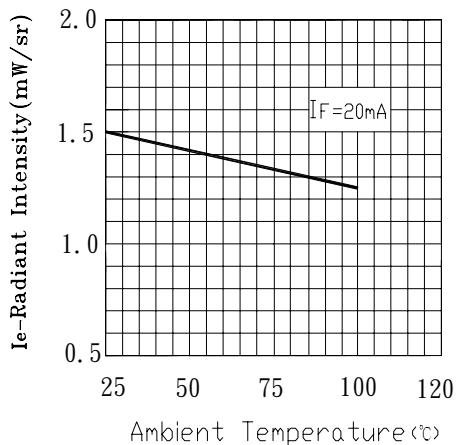
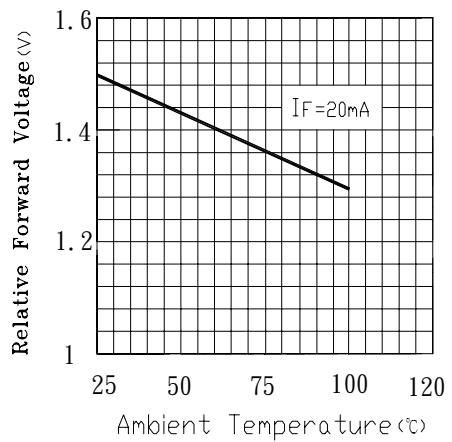
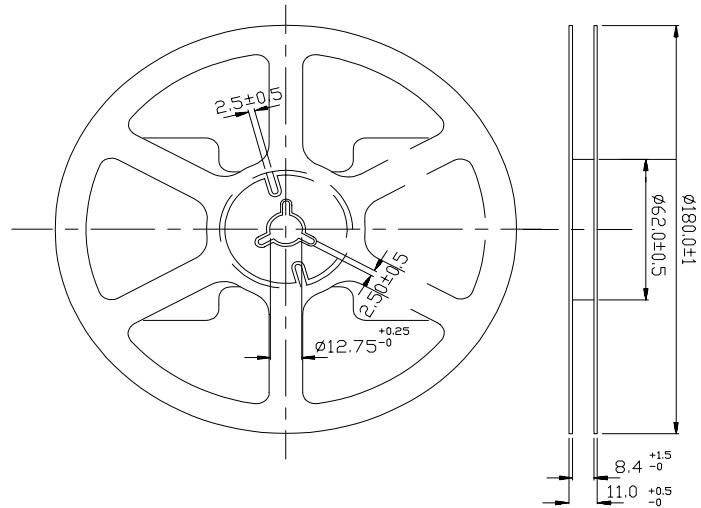


Fig. 8 Forward Voltage vs. Ambient Temperature (°C)

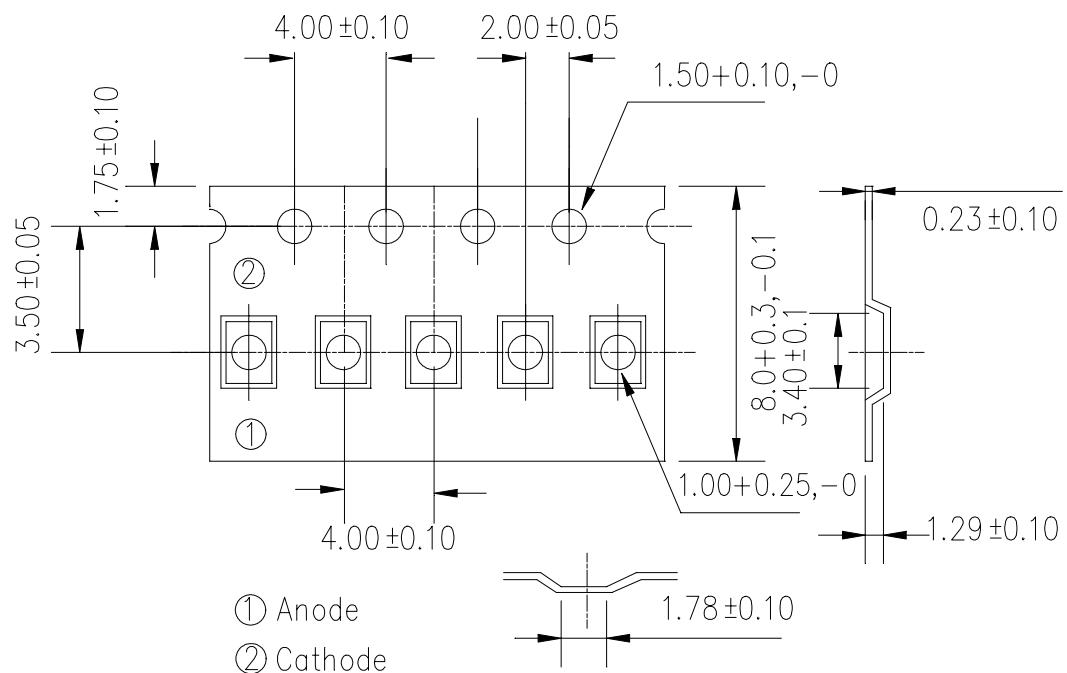


## **HIR15-21C/TR8**

### **Package Dimensions**



### **Loaded Quantity Per Reel 3000PCS/Reel**

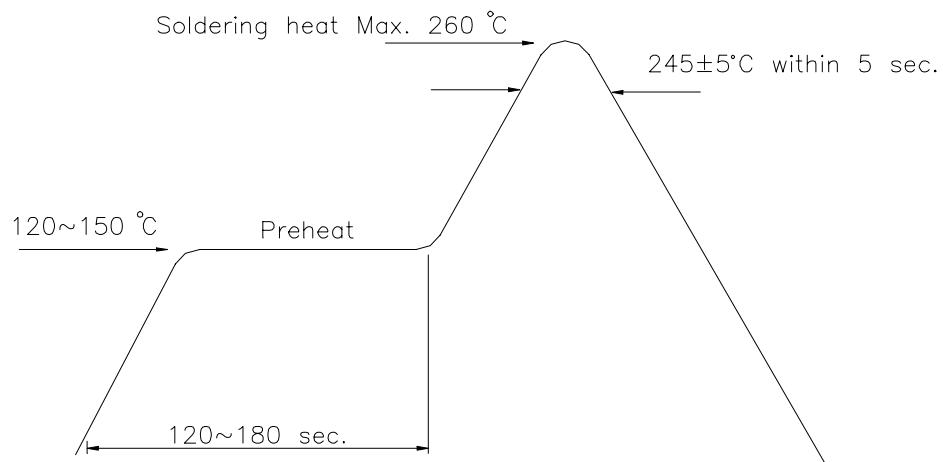


Unit : mm

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**Soldering heat reliability(DIP)**

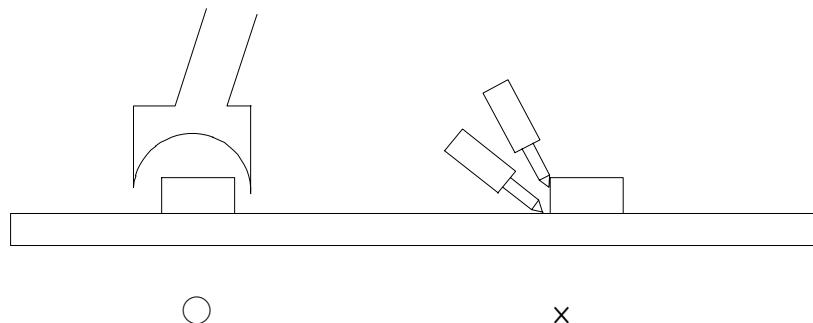
Please refer to the following figure

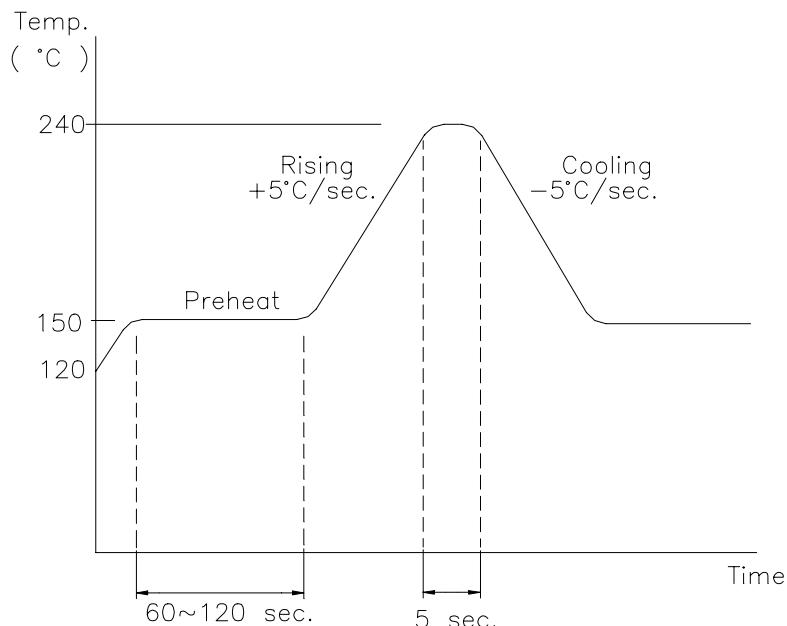
**Soldering Iron**

Basic spec is  $\leq 5$  sec when  $260\text{ }^{\circ}\text{C}$ . If temperature is higher, time should be shorter ( $+10\text{ }^{\circ}\text{C} \rightarrow -1\text{ sec}$ ). Power dissipation of Iron should be smaller than  $15\text{W}$ , and temperature should be controllable. Surface temperature of the device should be under  $230\text{ }^{\circ}\text{C}$ .

**Rework**

1. Customer must finish rework within 5 sec under  $245\text{ }^{\circ}\text{C}$ .
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.

**Device No:DTH-015-001**

**Reflow Temp./Time****Precautions For Use****1. Over-current-proof**

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change(Burn out will happen).

**2. Storage**

2.1 The operation of temperature and R.H are : 5°C~35°C , R.H.60%.

2.2 Once the package is opened , the products be should be used within a week.

Otherwise , they should be keep in a damp proof box with desiccating anent.

Considering the tape life , we suggest our customers to use our products within a year (from production date).

2.3 If opened more than one week in an atmosphere 5°C~35°C , R.H.60% . , they should be treated at 60°C± 5°C for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color(normal=blue), you should treat them in the same conditions as 2.3

**Device No:DTH-015-001**

**HIR15-21C/TR8****Reliability Test Item And Condition**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

NO.	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgement Criteria	Ac/Re
1	REFLOW	TEMP. : $240^{\circ}\text{C} \pm 5^{\circ}\text{C}$ 5secs	6mins	22pcs	More than 90% of lead to be covered by soldering	0/1
2	Temperature Cycle	H : $+85^{\circ}\text{C}$ L : $-55^{\circ}\text{C}$	30mins 5mins 30mins	50Cycles	22pcs	$I_R \geq U_x \cdot 2$ $E_e \leq L_x \cdot 0.8$
3	Thermal Shock	H : $+100^{\circ}\text{C}$ L : $-10^{\circ}\text{C}$	5mins 10secs 5mins	50Cycles	22pcs	$V_F \geq U_x \cdot 1.2$ U : Upper Specification Limit
4	High Temperature Storage	TEMP. : $+100^{\circ}\text{C}$	1000hrs	22pcs		0/1
5	Low Temperature Storage	TEMP. : $-55^{\circ}\text{C}$	1000hrs	22pcs		0/1
6	DC Operating Life	$I_F = 20\text{mA}$	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	$85^{\circ}\text{C} / 85\% \text{R.H}$	1000hrs	22pcs		0/1

**EVERLIGHT ELECTRONICS CO., LTD.**  
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,  
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936  
Fax: 886-2267-6244, 2267-6189, 2267-6306  
<http://www.everlight.com>

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